
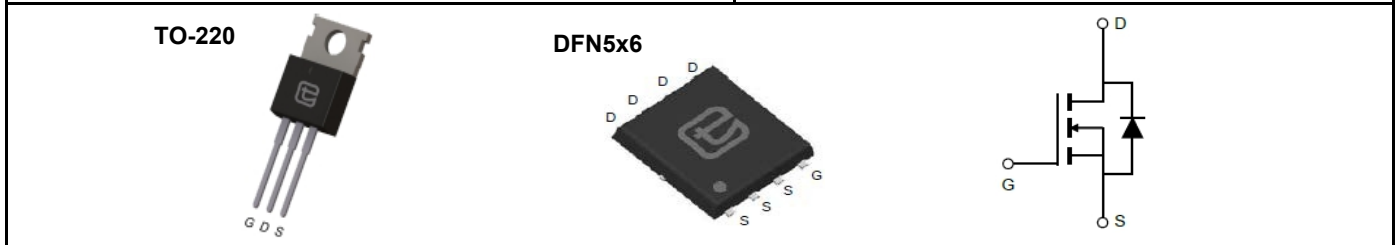




100V N-Channel SGT MOSFET

<p>General Description</p> <ul style="list-style-type: none"> ● Trench Power SGT technology ● Very low on-resistance $R_{DS(ON)}$ ● Low Gate Charge ● Excellent Gate Charge x $R_{DS(ON)}$ Product <p>Applications</p> <ul style="list-style-type: none"> ● High Frequency Switching and Synchronous Rectification 	<p>Product Summary</p> <table border="0"> <tr> <td>V_{DS}</td> <td>100V</td> </tr> <tr> <td>I_D (at $V_{GS}=10V$)</td> <td>100A</td> </tr> <tr> <td>$R_{DS(ON)}$ (at $V_{GS}=10V$)</td> <td>< 4.8mΩ</td> </tr> <tr> <td>$R_{DS(ON)}$ (at $V_{GS}=4.5V$)</td> <td>< 6mΩ</td> </tr> </table> <p>100% UIS Tested 100% DVDS Tested</p> 	V_{DS}	100V	I_D (at $V_{GS}=10V$)	100A	$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 4.8m Ω	$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	< 6m Ω
V_{DS}	100V								
I_D (at $V_{GS}=10V$)	100A								
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 4.8m Ω								
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	< 6m Ω								



Part Number	Package Type	Form	Marking
TSP048N10AT	TO-220	Tube	TSP048N10AT
TSG048N10AT	DFN5x6	Tape & Reel	TSG048N10AT

Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^B	I_D	$T_C = 25^\circ C$	100
		$T_C = 100^\circ C$	71
Pulsed Drain Current ^A	I_{DM}	400	A
Avalanche Current ^A	I_{AS}	30	A
Single Pulse Avalanche Energy ^A	E_{AS}	135	mJ
Power Dissipation ^C	P_D	$T_C = 25^\circ C$	166.5
		$T_C = 100^\circ C$	83.4
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Maximum	Units
Maximum Junction-to-Case	$R_{\theta JC}$	0.9	$^\circ C/W$
Maximum Junction-to-Ambient	$R_{\theta JA}$	50	



Electrical Characteristics($T_J = 25^\circ\text{C}$ unless otherwise noted)						
Symbol	Parameter	Conditions	Value			Units
			Min	Typ	Max	
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	100			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 100\text{V}, V_{GS} = 0\text{V}$	$T_J = 25^\circ\text{C}$		1	μA
			$T_J = 125^\circ\text{C}$		100	
I_{GSS}	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.1	1.5	2.5	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{V}, I_D = 30\text{A}$		4.2	4.8	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 30\text{A}$		5	6	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS} = 5\text{V}, I_D = 20\text{A}$		54		S
V_{SD}	Diode Forward Voltage	$I_S = 30\text{A}, V_{GS} = 0\text{V}$			1	V
I_S	Maximum Body-Diode Continuous Current ^B				100	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 50\text{V}, f = 1\text{MHz}$		4070.8		pF
C_{oss}	Output Capacitance			471		
C_{rss}	Reverse Transfer Capacitance			10.8		
R_g	Gate Resistance	$f = 1\text{MHz}$		1.7		Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS} = 10\text{V}, V_{DS} = 50\text{V}, I_D = 20\text{A}$		69.1		nC
$Q_g(4.5\text{V})$	Gate Source Charge			35.2		
Q_{gs}	Gate Source Charge			21.3		
Q_{gd}	Gate Drain Charge			4.92		
Q_{oss}	Output Charge	$V_{GS} = 0\text{V}, V_{DS} = 50\text{V}$		77.85		
$t_{D(on)}$	Turn-On Delay Time	$V_{GS} = 10\text{V}, V_{DS} = 50\text{V}, I_D = 20\text{A}, R_G = 1.8\Omega$		39.4		ns
t_r	Turn-On Rise Time			8.4		
$t_{D(off)}$	Turn-Off Delay Time			79.5		
t_f	Turn-Off Fall Time			12.8		
t_{rr}	Body Diode Reverse Recovery Time	$I_F = 20\text{A}, di/dt = 100\text{A}/\mu\text{s}$		61.6		ns
Q_{rr}	Body Diode Reverse Recovery Charge			146		nC

A. Single pulse width limited by maximum junction temperature.

B. The maximum current rating is package limited.

C. The power dissipation P_D is based on $T_{J(MAX)} = 175^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

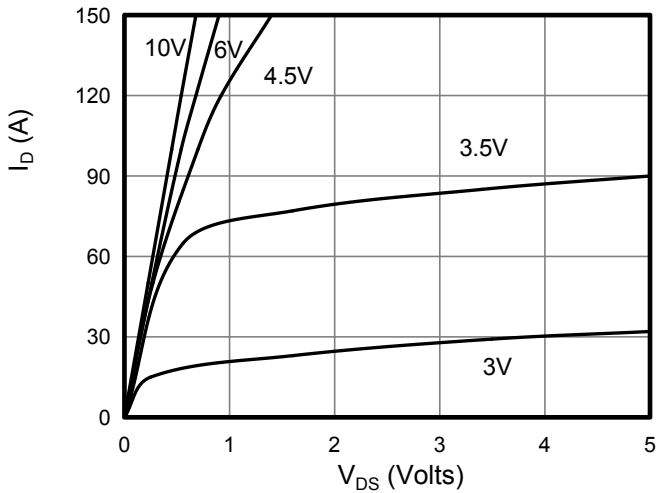


Figure 1: On-Region Characteristics

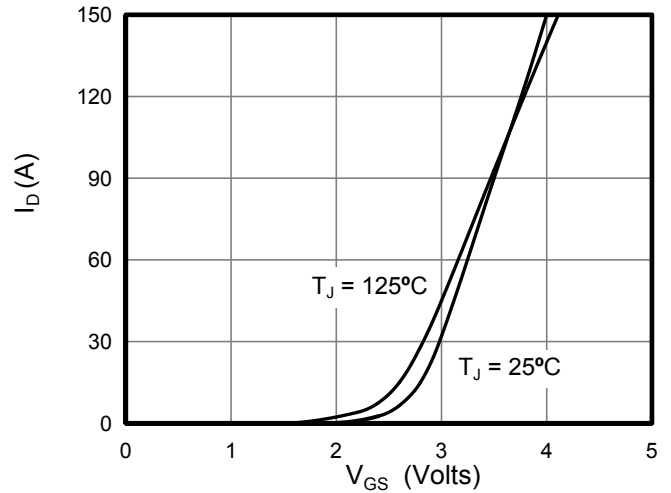


Figure 2: Transfer Characteristics

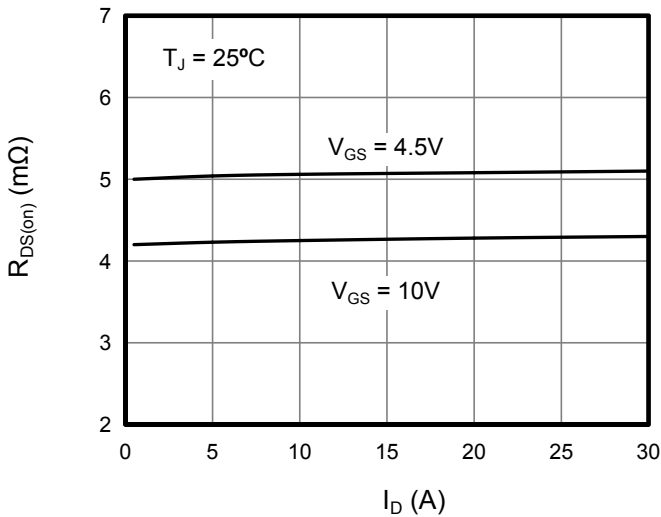


Figure 3: On-Resistance vs. Drain Current

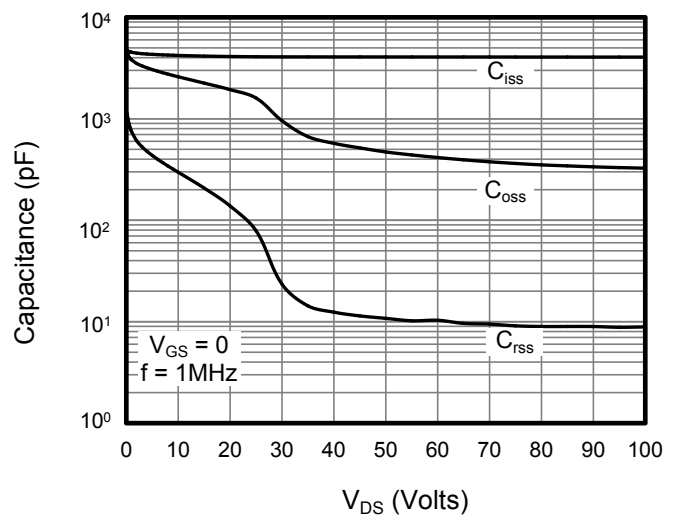


Figure 4: Capacitance Characteristics

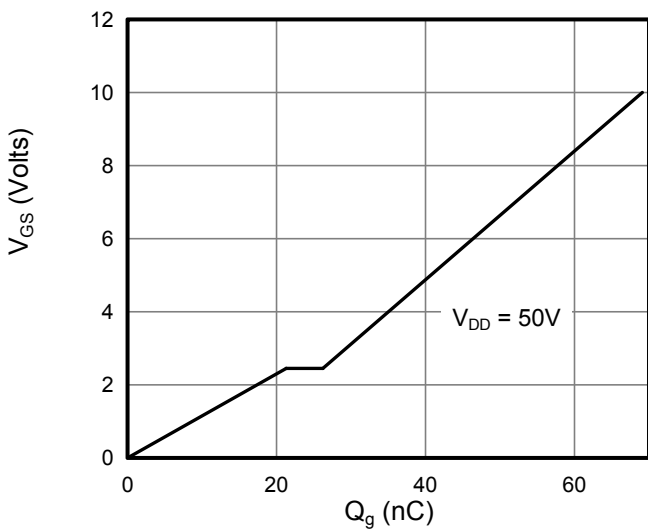


Figure 5: Gate Charge Characteristics

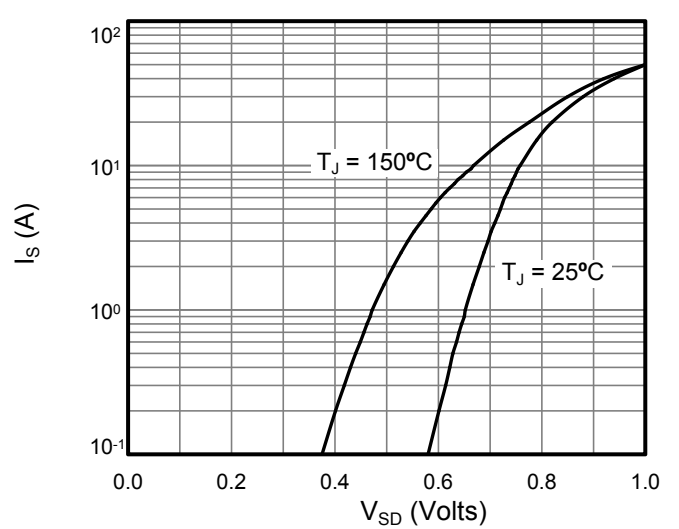


Figure 6: Body Diode Forward Voltage



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

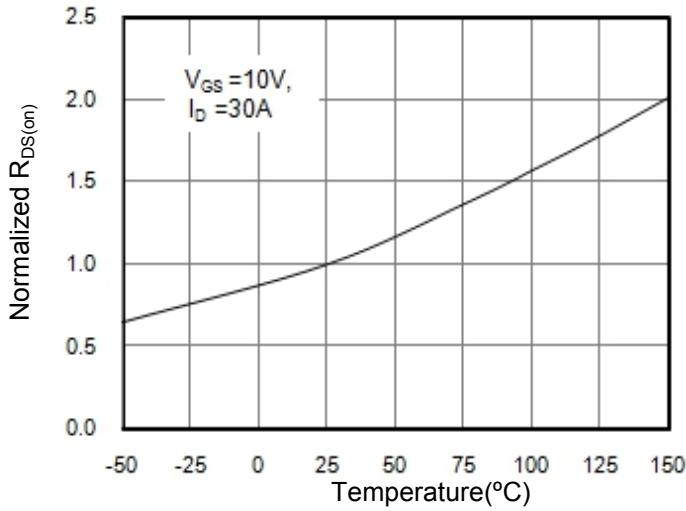


Figure 7: On-Resistance vs. Junction Temperature

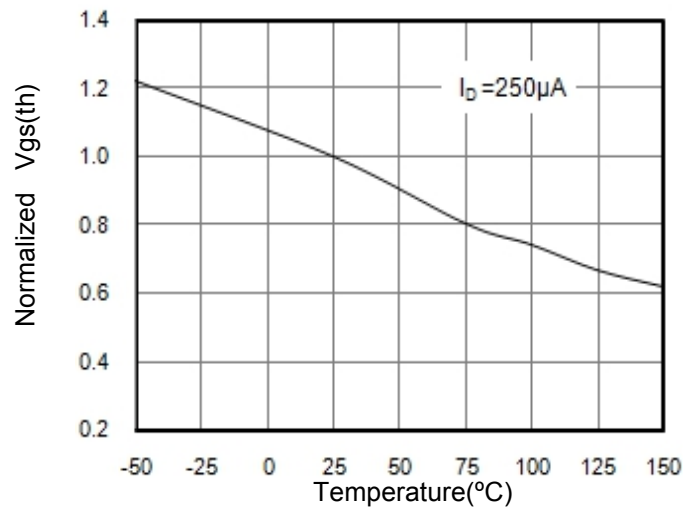


Figure 8: V_GS(th) vs. Junction Temperature

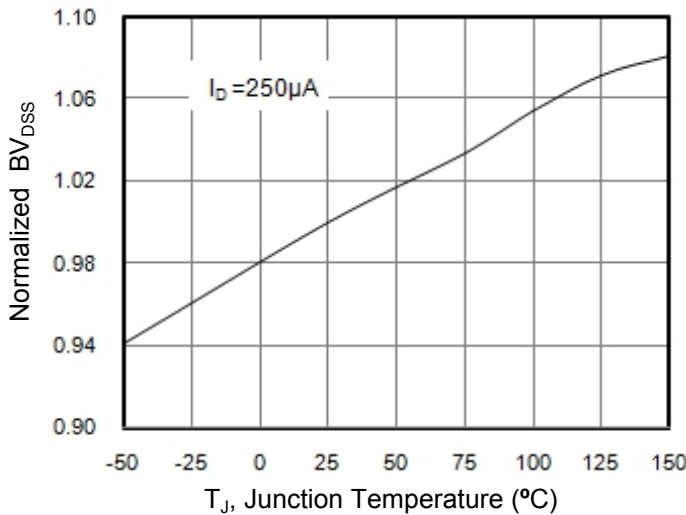


Figure 9: BV_DS vs. Junction Temperature

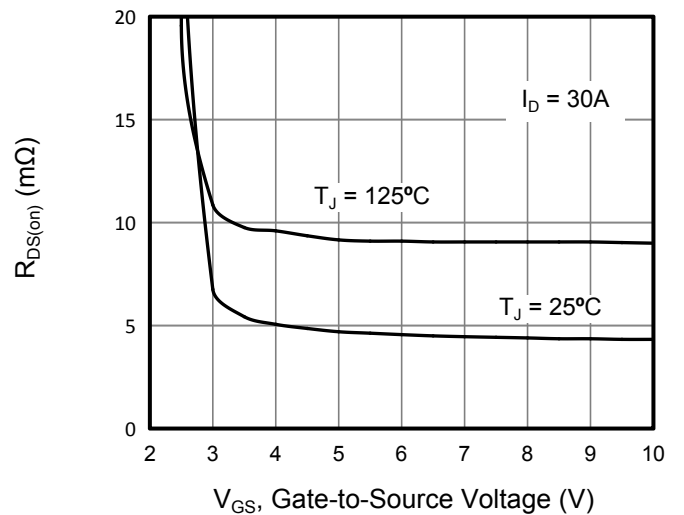


Figure 10: On-Resistance vs. Gate-Source Voltage

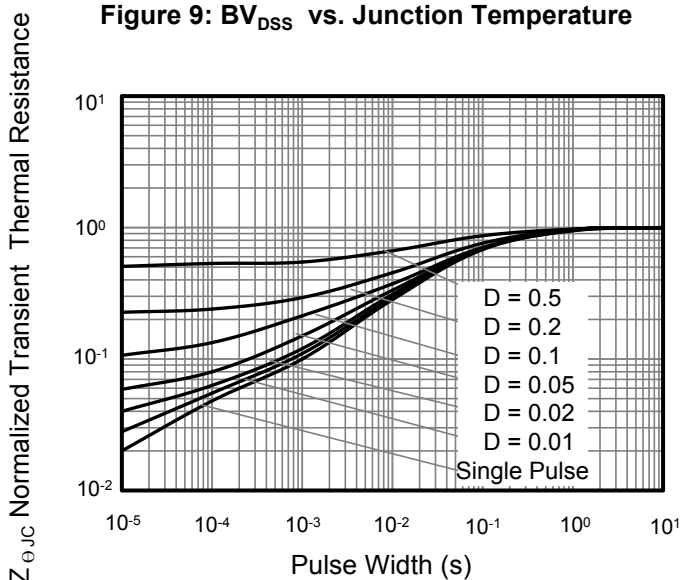


Figure 11: Normalized Transient Thermal Resistance

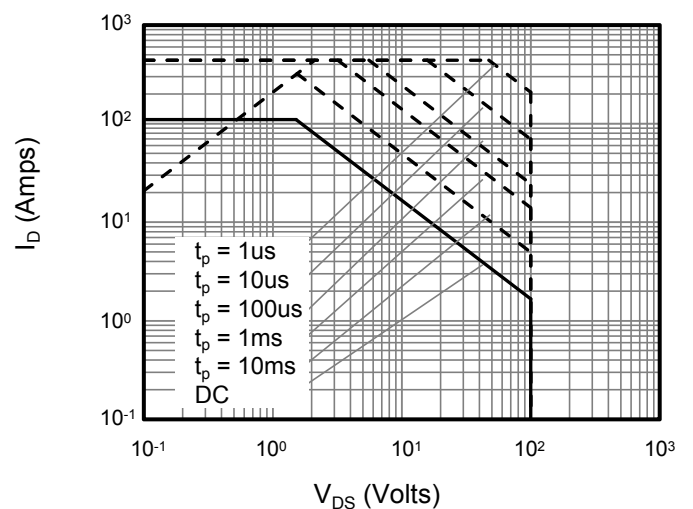


Figure 12: Safe Operating Area



Figure A: Gate Charge Test Circuit and Waveforms

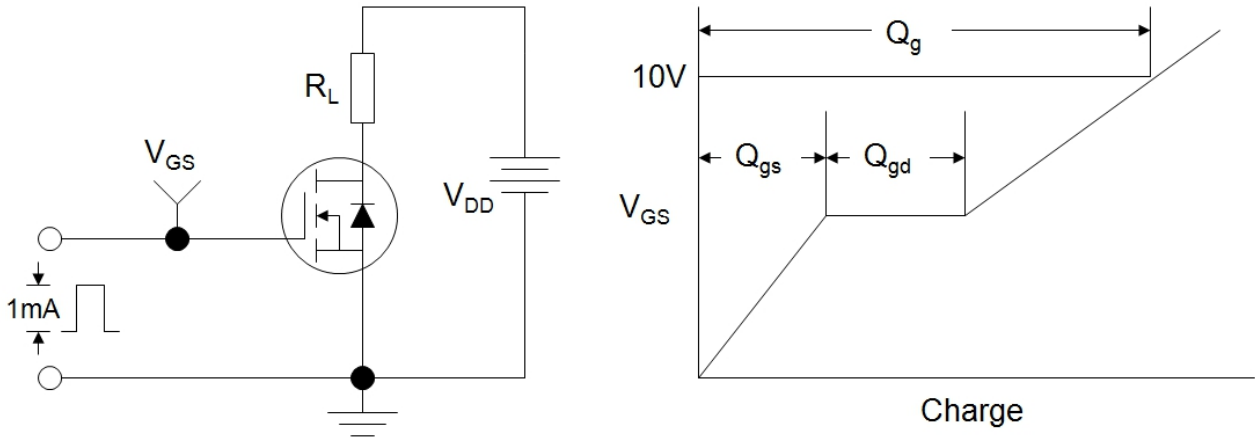


Figure B: Resistive Switching Test Circuit and Waveforms

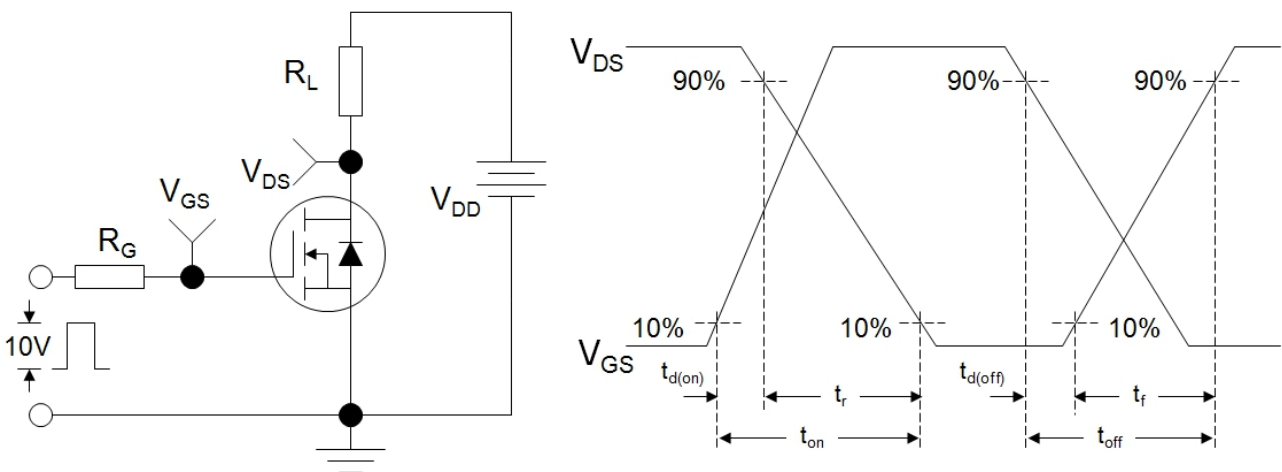
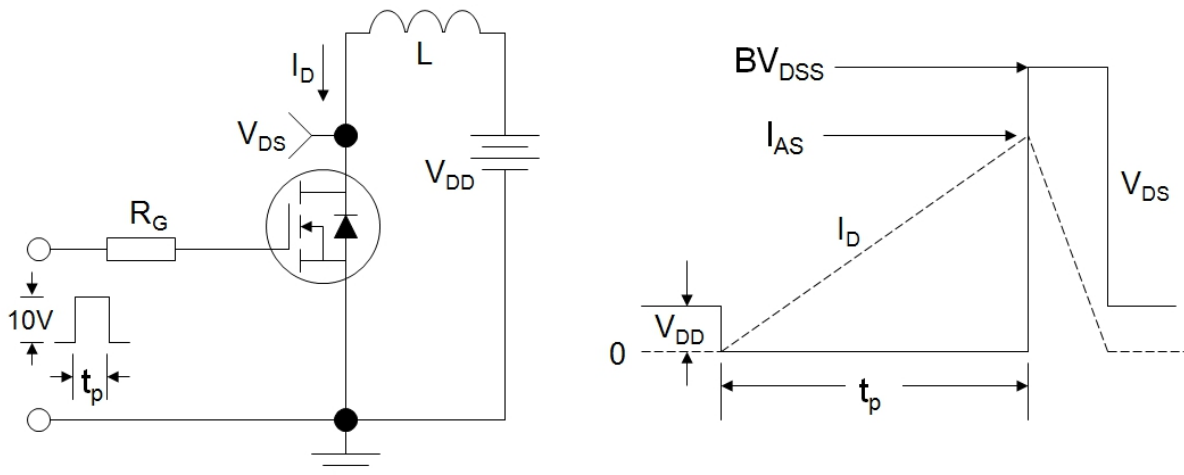
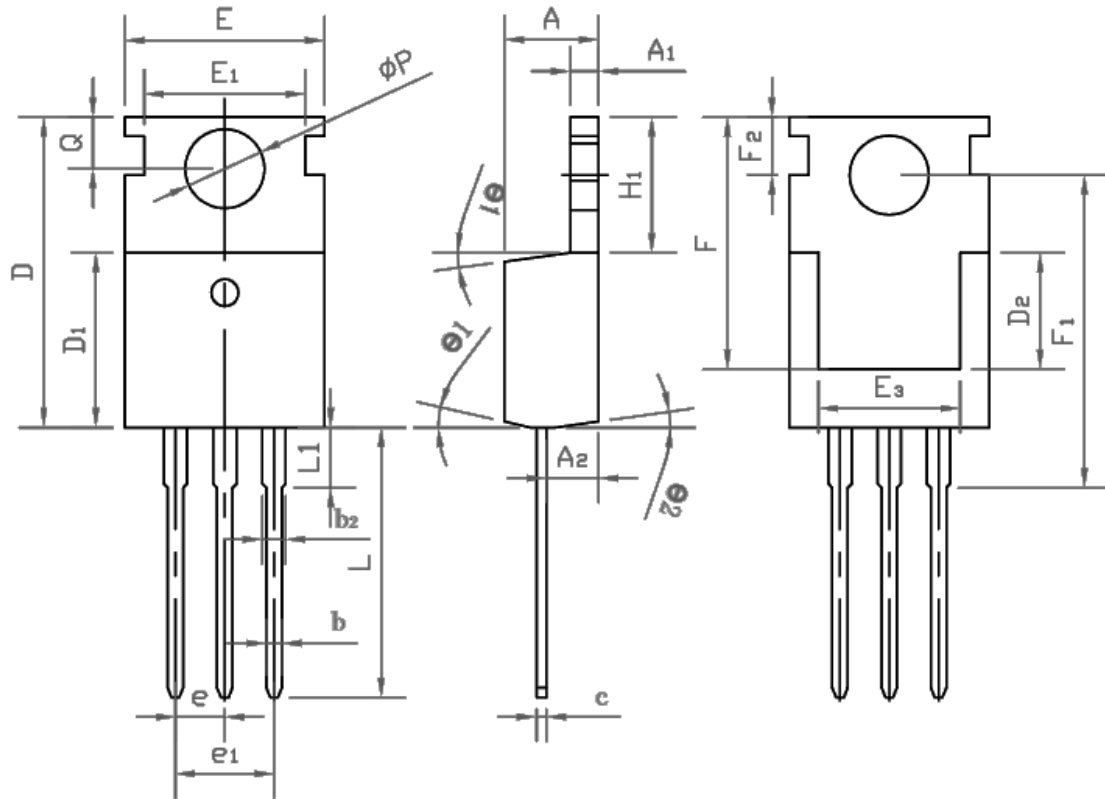


Figure C: Unclamped Inductive Switching (UIS) Test Circuit and Waveforms





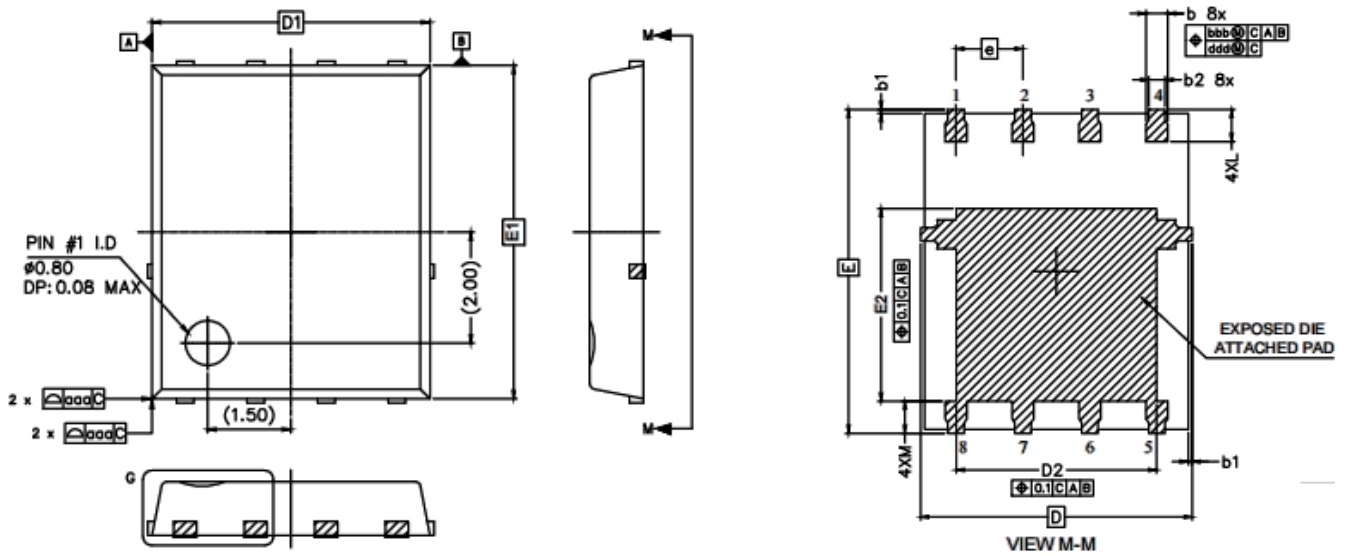
TO-220 (封装厂 E)



SYMBOL	MIN	NOM	MAX
A	4.27	4.57	4.87
A ₁	1.15	1.30	1.45
A ₂	2.10	2.40	2.70
b	0.70	0.80	1.00
b ₂	1.17	1.27	1.50
c	0.40	0.50	0.65
D	15.10	15.60	16.10
D ₁	8.80	9.10	9.40
D ₂	5.70	6.70	7.00
E	9.70	10.00	10.30
E ₁	-	8.70	-
E ₂	9.63	10.00	10.35
E ₃	7.00	8.00	8.40
e	2.54 BSC		
e ₁	5.08 BSC		
H ₁	6.00	6.50	6.85
L	12.75	13.50	13.90
L ₁	-	3.10	3.40
øP	3.45	3.60	3.75
Q	2.60	2.80	3.00
θ ₁	4°	7°	10°
θ ₂	0°	3°	6°
F	13.30	13.50	13.70
F ₁	15.50	15.90	16.30
F ₂	2.80	3.00	3.20



DFN5x6 (封装厂 A)



SYMBOL	MIN	MAX	SYMBOL	MIN	MAX
A	0.95	1.05	aaa	0.10	
A1	0.00	0.05	bbb	0.10	
A3	0.25 REF		ccc	0.10	
b	0.31	0.51	ddd	0.05	
b1	0.03	0.13	eee	0.08	
b2	0.21	0.41			
D	5.15 BSC				
D1	5.00 BSC				
D2	3.70	3.90			
E	6.15 BSC				
E1	6.00 BSC				
E2	3.56	3.76			
e	1.27 BSC				
L	0.51	0.71			
M	0.51	0.71			
P	10°	12°			



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